

SPECIFICATION

DEVICE NAME : Power MOSFET
TYPE NAME : 2SK2148-01R
SPEC. No. : 4

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

DATE	NAME	APPROVED		Fuji Electric Co.,Ltd.
DRAWN				
CHECKED				
			DWG. NO.	1/11

1. Scope
This specifies Fuji power MOSFET 2SK2148-01R
2. Construction N-channel enhancement mode power MOSFET
3. Application for switching
4. Outview T0-3PF Outview See to 5/11 page
5. Absolute maximum ratings at $T_c=25^\circ\text{C}$ (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-source voltage	V_{DS}	600	V	
Drain-gate voltage	V_{DGR}	600	V	$R_{GS}=20\text{K}\Omega$
Continuous Drain current	I_D	± 12	A	
Pulsed drain current	I_{Dpulso}	± 48	A	
Gate-source voltage	V_{GS}	± 30	V	
Maximum power dissipation	P_D	80	W	
Operating and storage temperature range	T_{ch} T_{sto}	150 -55 ~ +150	$^\circ\text{C}$ $^\circ\text{C}$	

6. Electrical characteristics at $T_c=25^\circ\text{C}$ (unless otherwise specified)
- Static ratings

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Drain-source breakdown voltage	BV_{DSS}	$I_D=1\text{mA}$ $V_{GS}=0\text{V}$	600			V
Gate threshold voltage	$V_{GS(th)}$	$I_D=1\text{mA}$ $V_{DS}=V_{GS}$	2.5	3.0	3.5	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=600\text{V}$ $V_{GS}=0\text{V}$ $T_{ch}=25^\circ\text{C}$		10	500	μA
	I_{DSS}	$T_{ch}=125^\circ\text{C}$		0.2	1.0	mA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm 30\text{V}$ $V_{DS}=0\text{V}$		10	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$I_D=6\text{A}$ $V_{GS}=10\text{V}$		0.55	0.75	Ω

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Dynamic ratings

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Forward transconductance	g_{fs}	$I_D = 6A$ $V_{DS} = 25V$	6	12		S
Input capacitance	C_{iss}	$V_{DS} = 25V$ $V_{GS} = 0V$ $f = 1MHz$		2500	3800	pF
Output capacitance	C_{oss}			220	330	pF
Reverse transfer capacitance	C_{rss}			50	75	pF
Turn-on time	$t_{d(on)}$	$V_{CC} = 300V$ $V_{GS} = 10V$ $I_D = 12A$ $R_{GS} = 10\Omega$		30	45	ns
	t_r			60	90	ns
Turn-off time	$t_{d(off)}$			140	210	ns
	t_f			80	120	ns

Reverse diode

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Avalanche capability	I_{AV}	$L = 100\mu H$, $T_{ch} = 25^\circ C$ * See Fig1 & 2	12			A
Diode forward on-voltage	V_{SD}	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V$, $T_{ch} = 25^\circ C$		1.05	1.58	V
Reverse recovery time	t_{rr}	$I_F = I_{DR}$ $V_{GS} = 0V$ $-di_F/dt = 100A/\mu s$ $T_{ch} = 25^\circ C$		450		ns
Reverse recovery charge	Q_{rr}			3		μC

7. Thermal resistance

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th_{ch-c}}$				1.56	$^\circ C/W$
	$R_{th_{ch-a}}$				30.0	$^\circ C/W$

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Fig.1 Test circuit

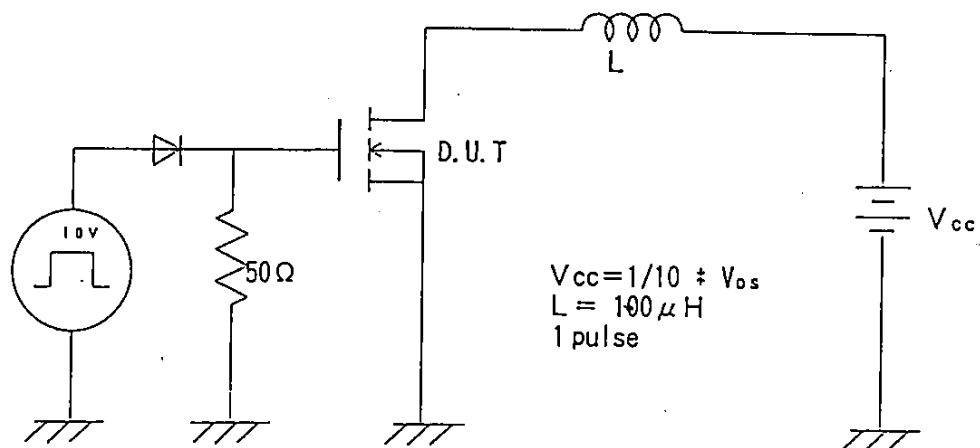
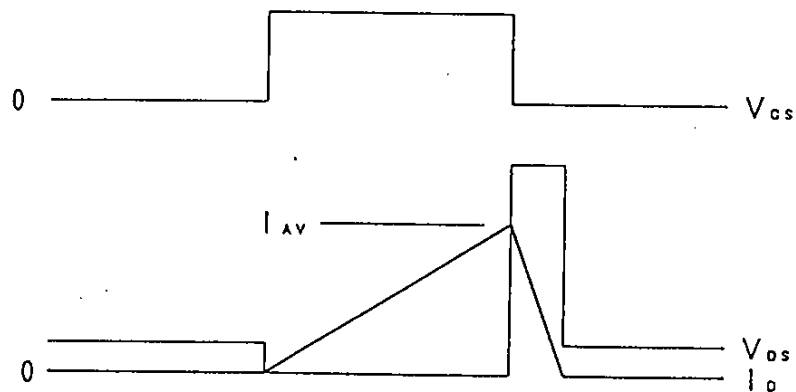
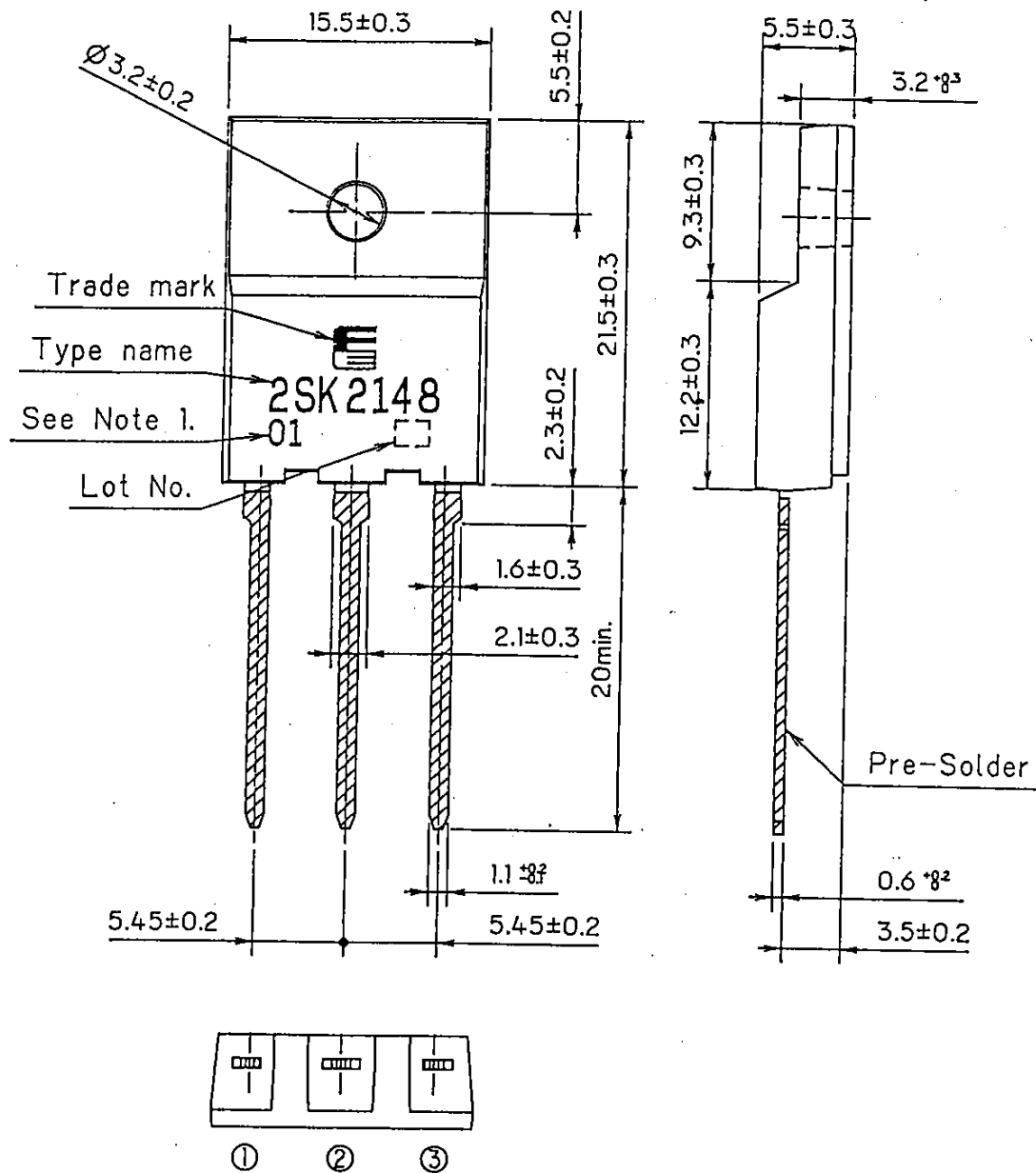


Fig.2 Operating waveforms



FUJI POWER MOSFET

TYPE : 2SK2148-01R



CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

Note 1. Guaranteed mark of avalanche ruggedness.

DIMENSIONS ARE IN MILLIMETERS.

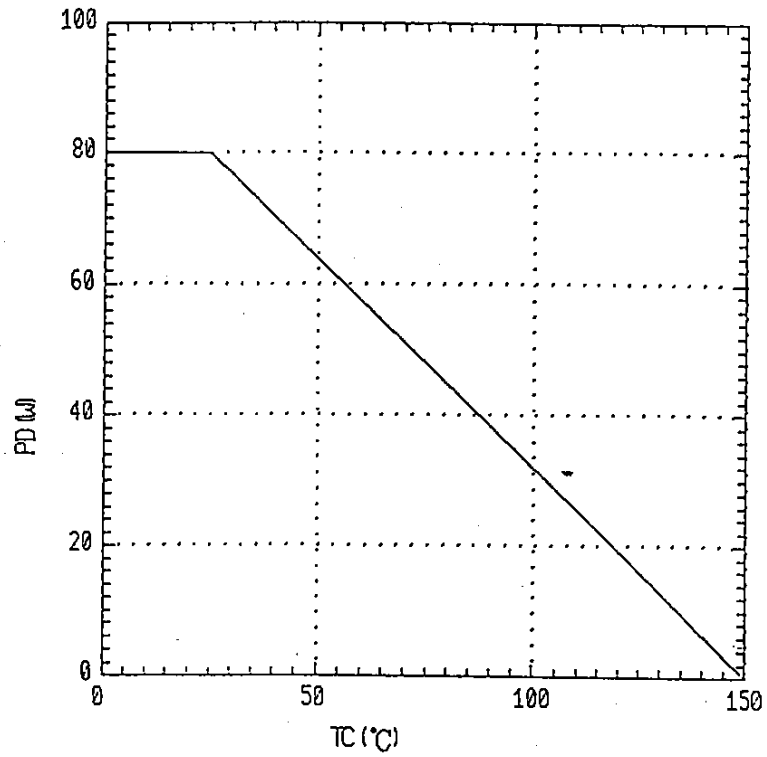
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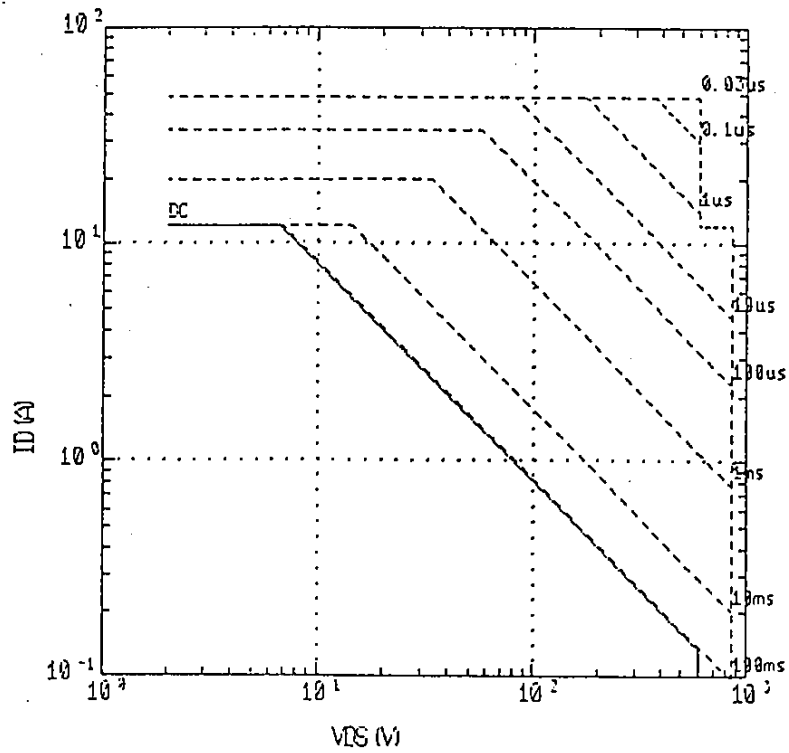
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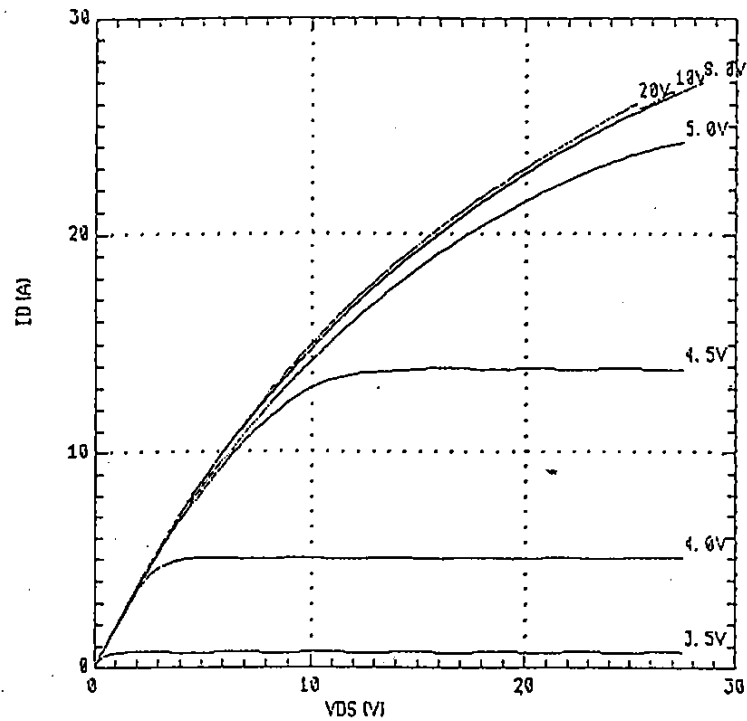
Power Dissipation
 $PD=f(TC)$



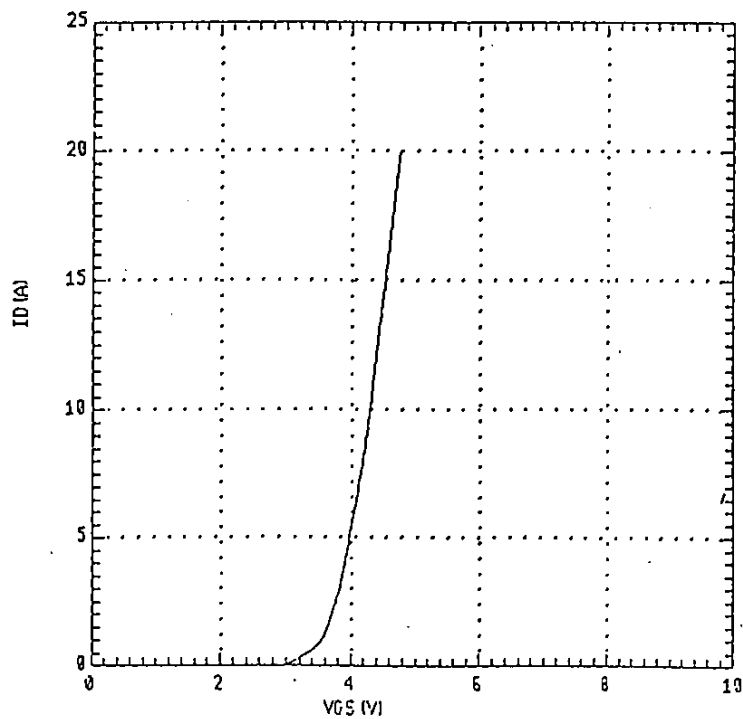
Safe operating area
 $ID=f(VDS): D=0.01, Tc=25^{\circ}C$



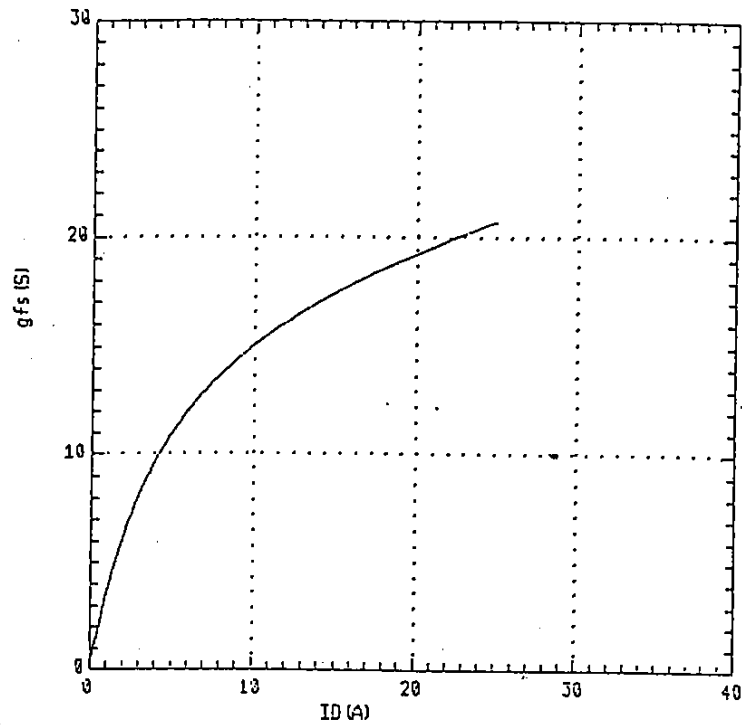
Typical output characteristics
 $I_D = f(V_{DS})$: 80 μ s pulse test, $T_{ch} = 25^\circ\text{C}$



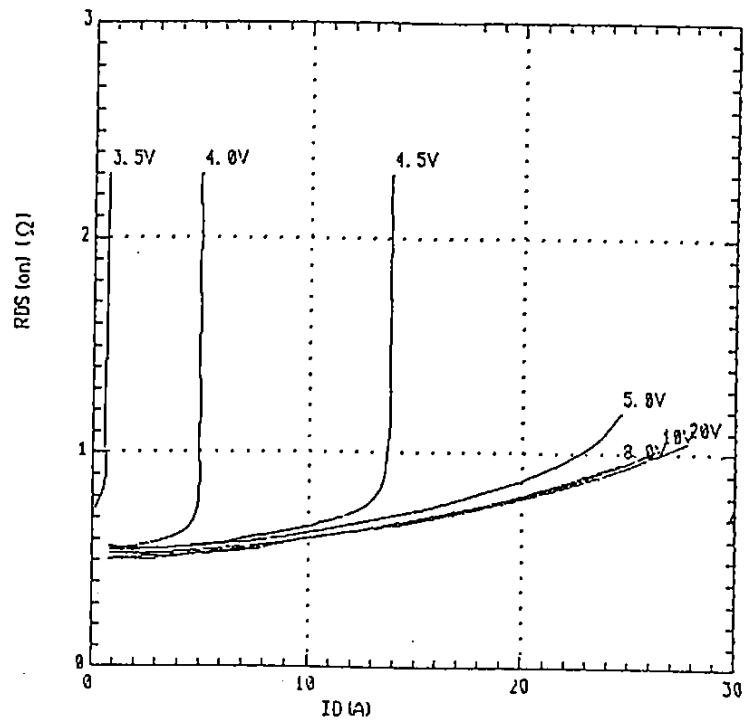
Typical Transfer Characteristic
 $I_D = f(V_{GS})$: 80 μ s pulse test, $V_{DS} = 25\text{V}$



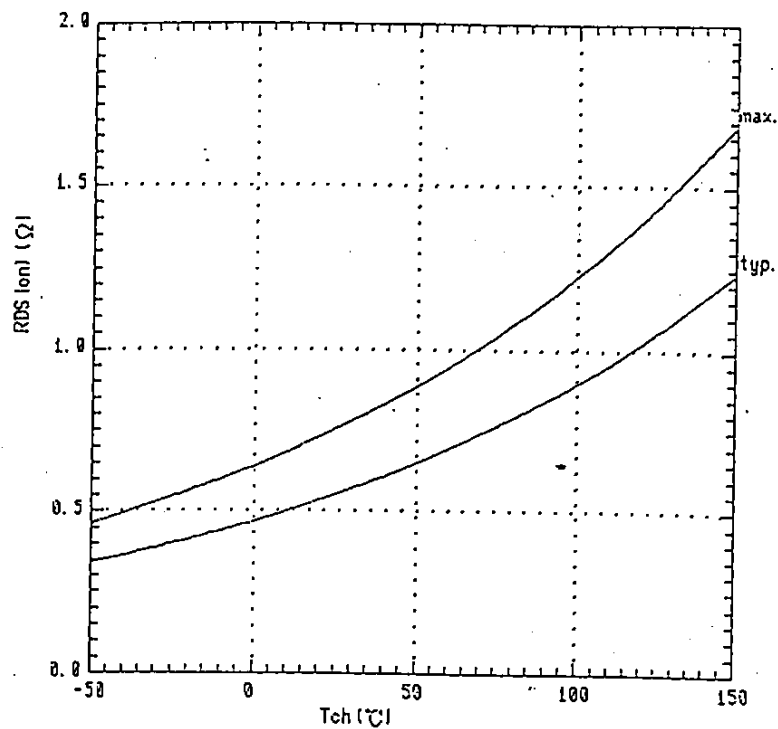
Typical Transconductance
 $g_{fs}=f(I_D): 80\mu s$ pulse test, $V_{DS}=25V$, $T_{ch}=25^\circ C$



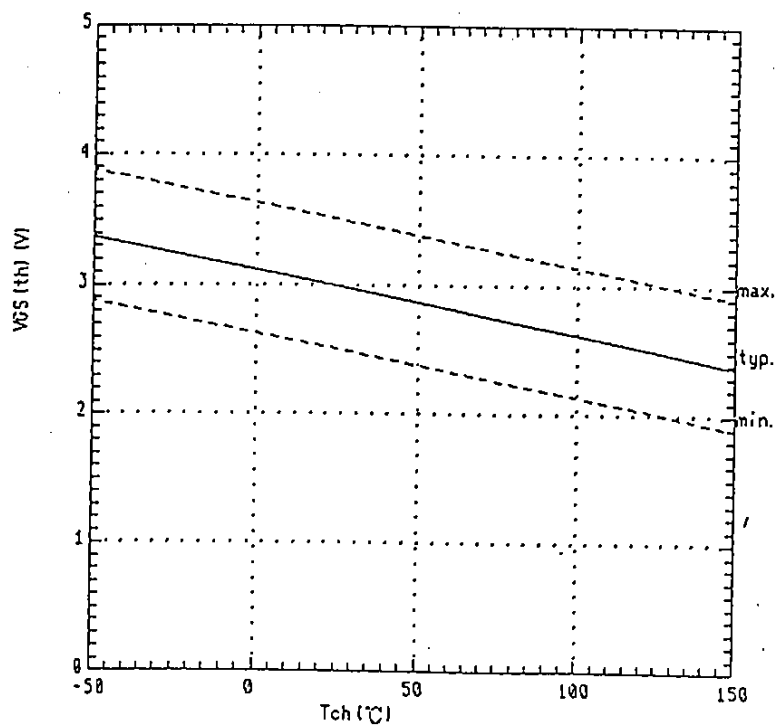
Typical Drain-source on-state resistance
 $R_{DS(on)}=f(I_D): 80\mu s$ pulse test, $T_{ch}=25^\circ C$



Drain-source on-state resistance
 $R_{DS(on)} = f(T_{ch}) : I_D = 6A, V_{GS} = 10V$



Gate threshold voltage
 $V_{GS(th)} = f(T_{ch}) : V_{DS} = V_{GS}, I_D = 1mA$



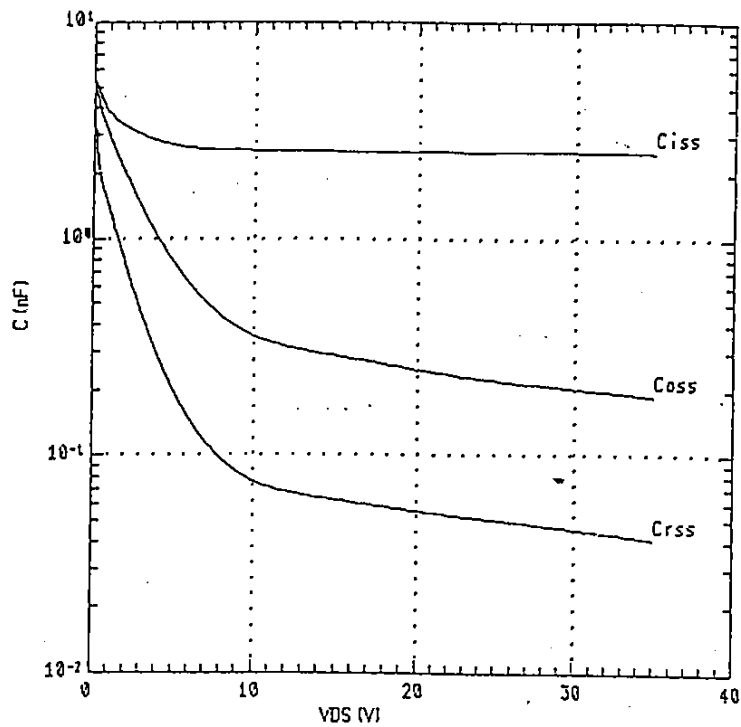
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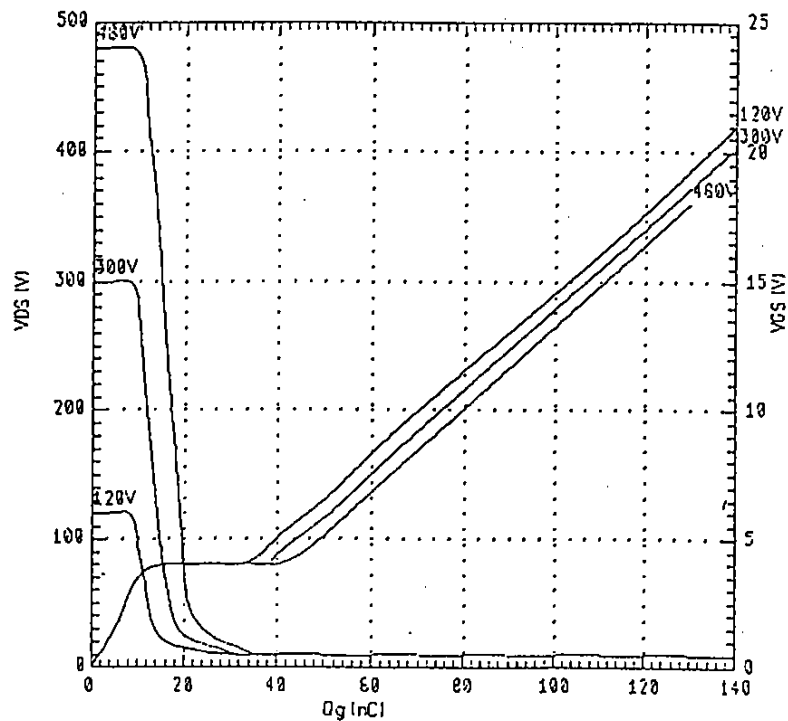
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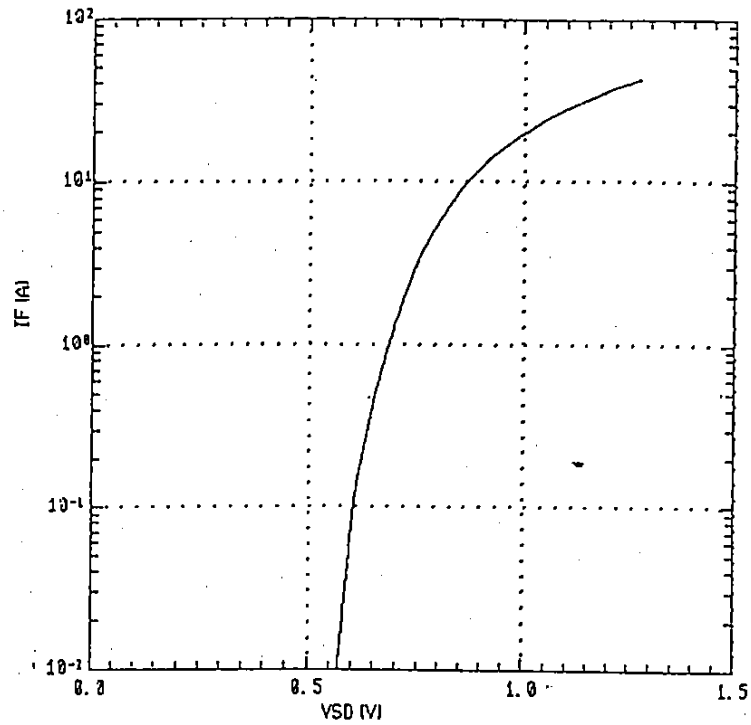
Typical capacitances
 $C=f(V_{DS}):V_{GS}=0V, f=1MHz$



Typical gate charge characteristics
 $V_{GS}=f(Q_g):I_D=12A$



Forward characteristic of reverse diode
 $I_F = f(V_{SD}) : 80 \mu s$ pulse test



Transient thermal
 impedance $Z_{thch-c} = f(t)$ parameter: $D = t/T$

